













- ► PCB / CHIP LED
- ▶ 1206 (3216) 1.85t
- ► Infrared (940nm)

N0F63S34



1206 (3216) 1.85t





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APPLICATIONS:

- Indication Light
- Switch Light
- 3C Application

FEATURES:

Package: PCB / CHIP LED Top View with Lens

Forward Current: 20mA Forward Voltage (typ.): 1.4V

Radiant Intensity (typ.): 26mW/sr@20mA

Colour: Infrared (IR) Wavelength: 940nm Viewing angle: 20°

Materials: Die: GaAlAs

Resin: Epoxy (Water Clear) Operating Temperature: -40~+85°C

Storage Temperature: -40~+85°C

Grouping parameters:

Forward voltage

Radiant intensity

Peak wavelength

Soldering methods: Reflow MSL Level: 3 acc. to JEDEC

Packing: 8mm tape with max.2000/reel, ø180mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	l _F	100	mA
Peak Forward Current pulse width 10μs 1% duty cycle	Ігр	0.5	А
Reverse Voltage	V_R	5	V
Reverse Current @5V	I _R	10	μΑ
Power Dissipation	P _D	70	mW
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+85	°C
Soldering Temperature	T _{SOL}	260	°C

Electrical & Optical Characteristics (Ta=25°C)

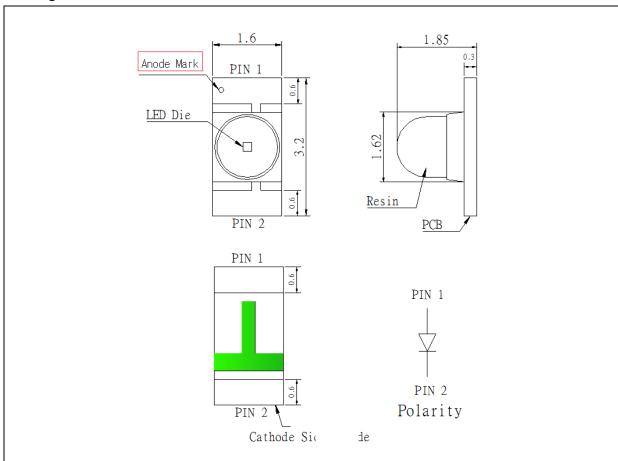
Daramatar Sumba		Values			Linia	Test
Parameter Symi	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V_{F}	1.2	1.4	2.0	V	I _F =20mA
Radiant Intensity	Ee	20	26		mW/sr	I _F =20mA
Peak Wavelength	$\lambda_{ ext{P}}$		940		nm	I _F =20mA
Spectral Line Half Bandwidth	Δλ		30		nm	I _F =20mA
Rise Time	T_R			15	ns	
Fall Time	T _F			10	ns	
Viewing Angle	2θ _{1/2}		20		deg	I _F =20mA

^{1.} Luminous intensity (Iv) $\pm 15\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$



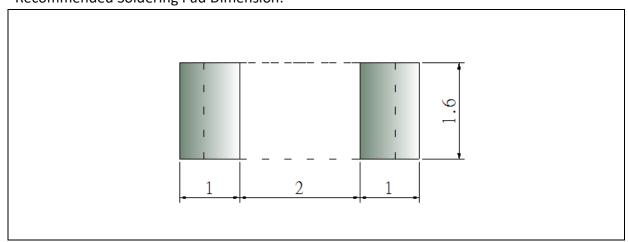
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
D5	1.2	1.4	
D6	1.4	1.6	V
E5	1.6	1.8	V
E6	1.8	2.0	

Radiant Intensity Classifications (I_F = 20mA):

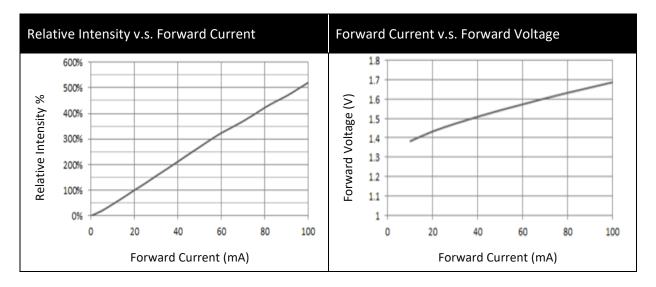
Code	Min.	Max.	Unit
PM	20.0	22.5	
PN	22.5	25.0	
PP	25.0	27.5	mW/sr
PQ	27.5	30.0	
PR	30.0	32.5	

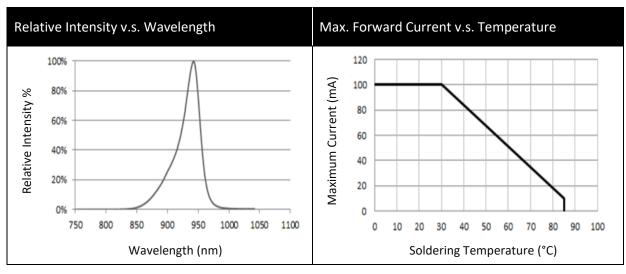
Peak Wavelength Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
В	920	960	nm



ELECTRO-OPTICAL CHARACTERISTICS:

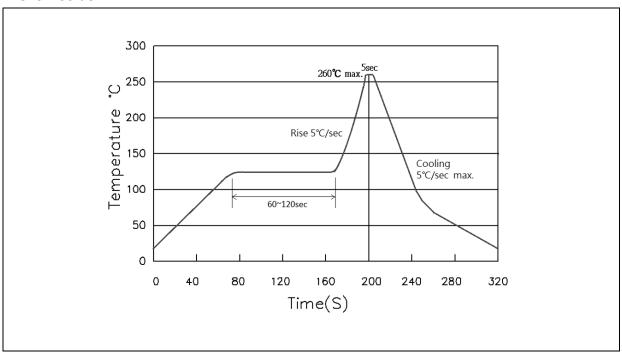






RECOMMENDED SOLDERING PROFILE:

Reflow Solder:



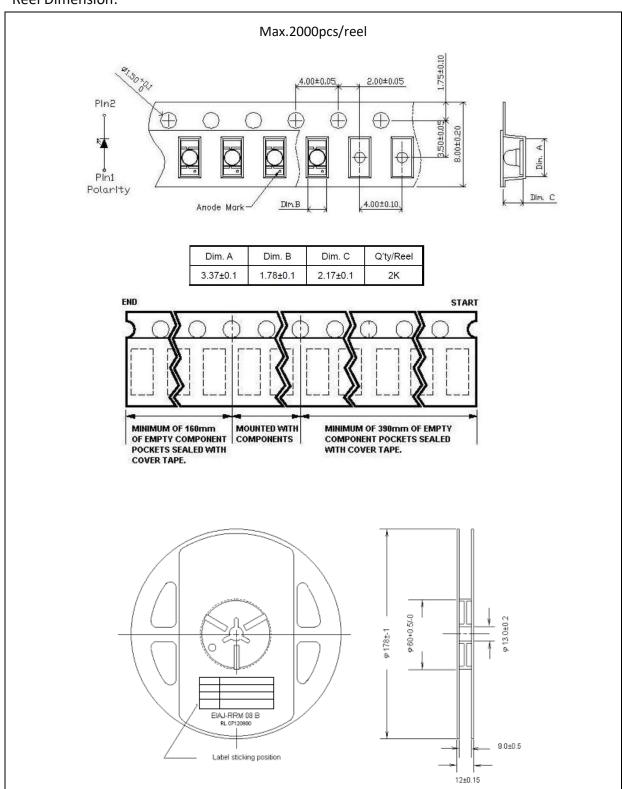
Note:

- 1. Recommend reflow temperature 245°C. The maximum soldering temperature should be limited to 260°C.
- 2. Maxima reflow soldering: 1 time.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

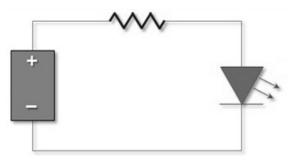
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±5°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	02/12/2022	Datasheet set-up.

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